2SC2229

Rev.E Mar.-2016

蓝箭电子
BLUE ROCKET ELECTRONICS

DATA SHEET

/ Descriptions

WR0<50P ṂṂŁ QSQ ӕṀҷ s ǁ ᒣ Silicon NPN transistor in a TO-92LM Plastic Package.

/ Features

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High breakdown voltage, low output capacitance, high f_T.

/ Applications

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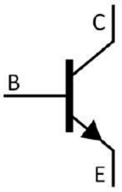
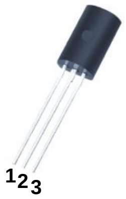
TV video output, high voltage switching and driver stage of audio amplifier applications.

/ Equivalent Circuit



/ Pinning



PIN1 χ Base PIN 2 χ Collector PIN 3 χ Emitter

/ h_{FE} Classifications & Marking

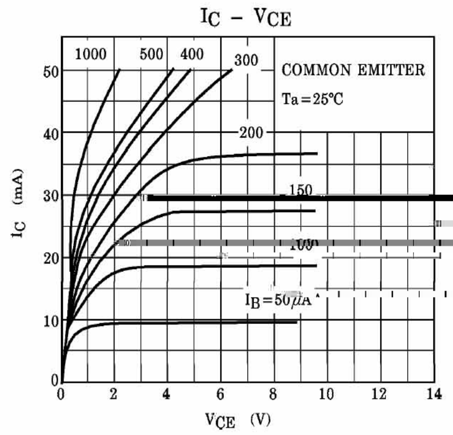
h_{FE} Classifications Symbol	O	Y
h_{FE} Range	70 140	120 240

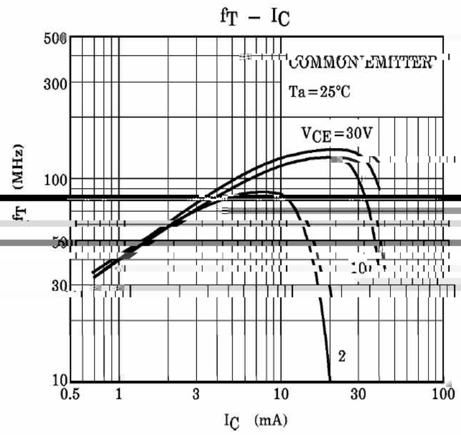
v ῼ Parameter	ɥ ᴺ Symbol	ῼӪ Rating	ᴅ Ʉ Unit
Collector to Base Voltage	V_{CBO}	200	V
Collector to Emitter Voltage	V_{CEO}	150	V
Emitter to Base Voltage	V_{EBO}	5.0	V
Collector Current (DC)	I_C	50	mA
Emitter Current	I_E	-50	mA
Collector Power Dissipation	P_C	800	mW
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 150	

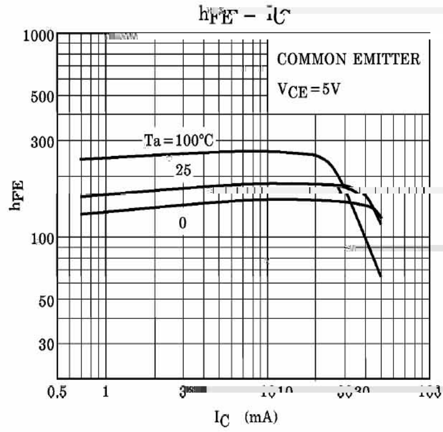
v ῼ Parameter	ɥ ᴺ Symbol	╜ ፧ꜛ ʈ Test Conditions	ῳ ṇ Ӫ Min	Ɛ ʒ Ӫ Typ	ῳ ⪥ Ӫ Max	ᴅ Ʉ Unit
Collector Cut-Off Current	I_{CBO}	V_{CB}=200V I_E=0			0.1	µA
Emitter Cut-Off Current	I_{EBO}	V_{EB}=5.0V I_C=0			0.1	µA

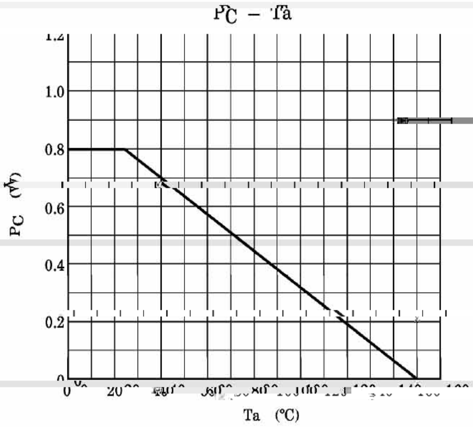
DC Current Gain h_{FEFEC} 0 7.02 238.56 394.40 399892003 Tc0 Tw6C

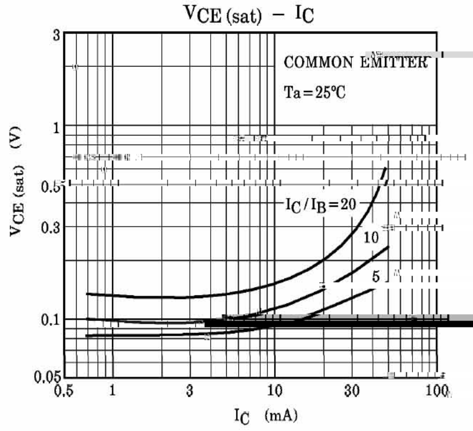
/ Electrical Characteristic Curve

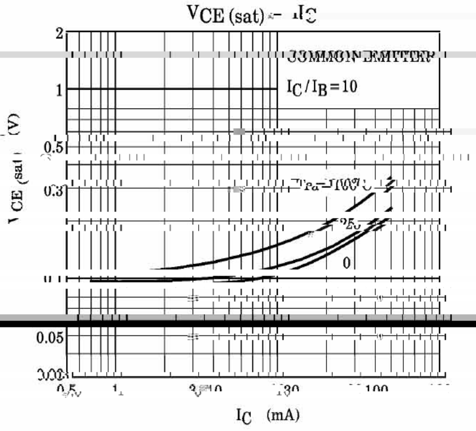






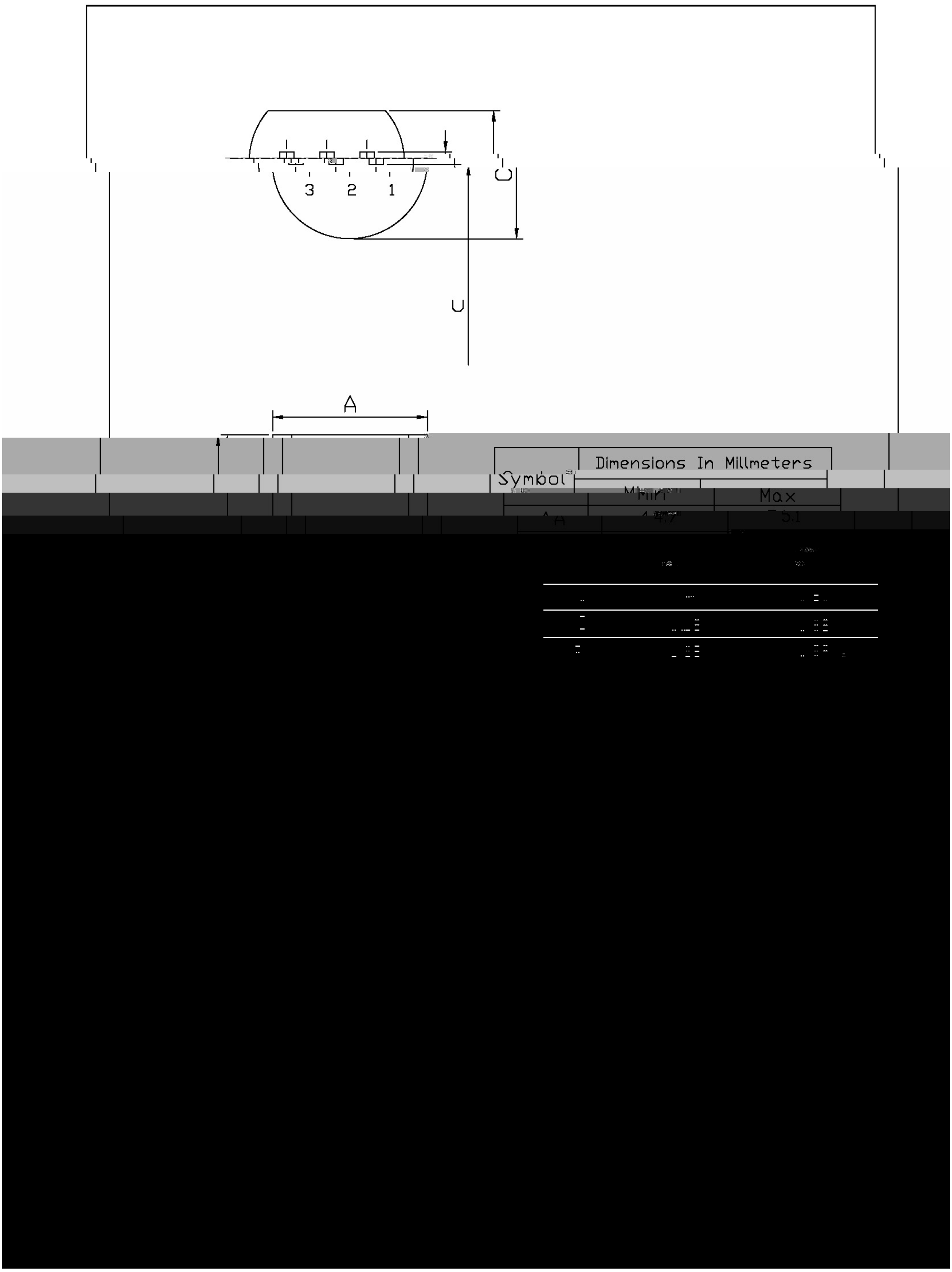






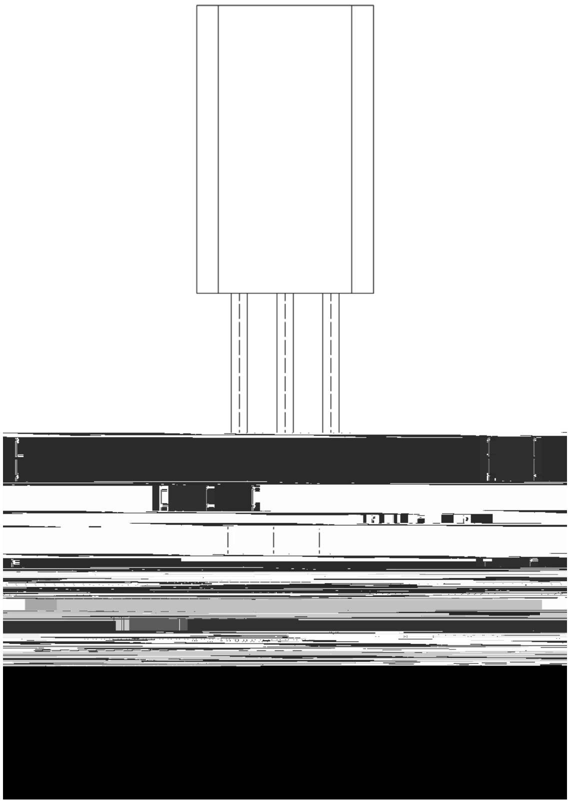
/ Package Dimensions

TO-92LM Unit: mm



Symbol	Dimensions In Millmeters	
	Min	Max
A	4.7	5.1

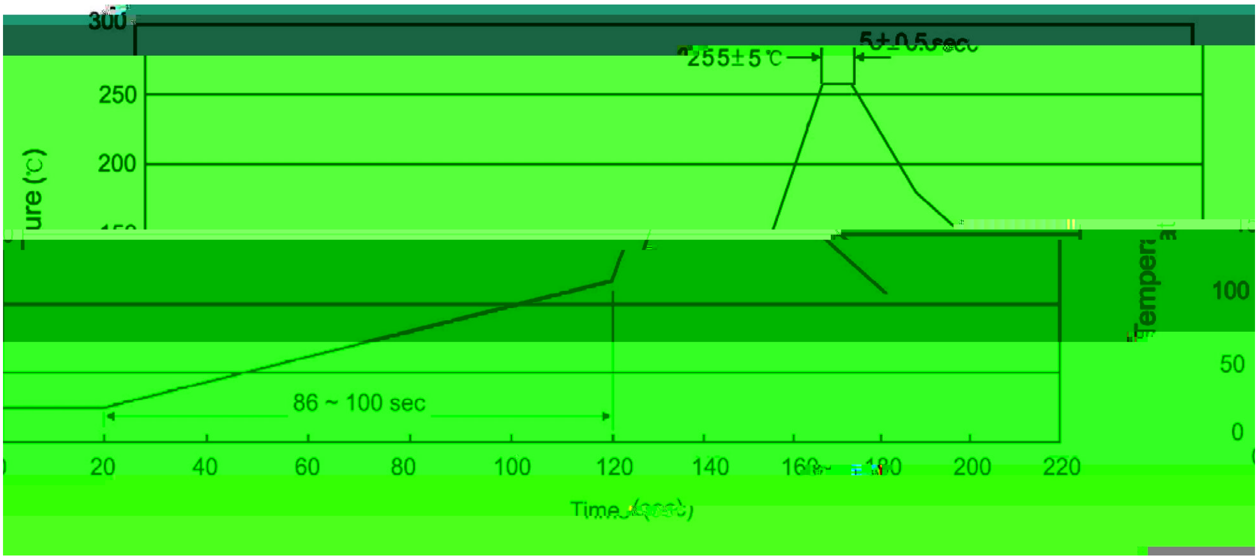
/ Marking Instructions



ب ˝ χ

EU꞊	Ѭ ɜ ᴎ Ꮒ
F555< χ	Ѭ ʒ ᴺ Ꮒ

( ) / Temperature Profile for Dip Soldering(Pb-Free)



ب ˝ χ

1 ʆ ♬ □ ẙ 25 Ḱ 150 ł ı `H ڗ 60 Ḱ 90sec;

2 Š Ӫ □ ẙ 255 ° 5 ł ı `H ڗ `Y ߀ ㎱ 5 ° 0.5sec;

3 ì ˙ ˥ ˛ ɔ ﻫ ẙ ㎱ 2 Ḱ 10 ł /sec.

Note:

1.Preheating:25~150 ł , Time:60~90sec.

2.Peak Temp.:255 ° 5 ł , Duration:5 ° 0.5sec.

3. Cooling Speed: 2~10 ł /sec.

/ Resistance to Soldering Heat Test Conditions

□ ẙ χ 270 ° 5 ł `H ڗ χ 10 ° 1 sec. Temp.:270±5 Time:10±1 sec

/ Packaging SPEC.

ʺΩ ʈ ɣ ŀ / BULK